2SK3133(L),2SK3133(S)

Silicon N Channel MOS FET High Speed Power Switching

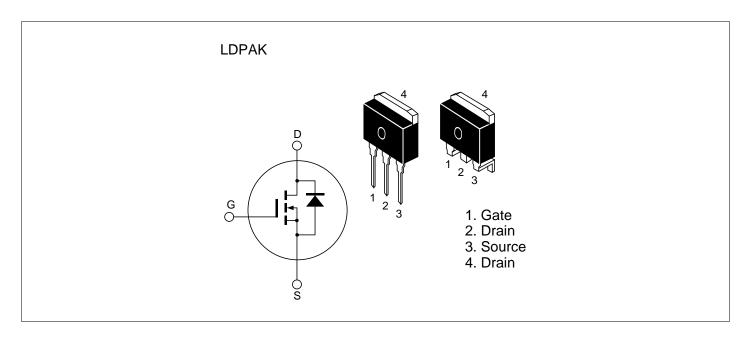
HITACHI

ADE-208-720 (Z) Target Specification 1st. Edition February 1999

Features

- Low on-resistance $R_{DS(on)} = 7 \text{ m}\Omega \text{ typ.}$
- Low drive current
- 4 V gate drive device can be driven from 5 V source

Outline





2SK3133(L),2SK3133(S)

Absolute Maximum Ratings $(Ta = 25^{\circ}C)$

| Item | Symbol | Ratings | Unit |
|--|-------------------|-------------|------|
| Drain to source voltage | $V_{	exttt{DSS}}$ | 30 | V |
| Gate to source voltage | $V_{\sf GSS}$ | ±20 | V |
| Drain current | I _D | 50 | A |
| Drain peak current | Note 1 | 200 | A |
| Body-drain diode reverse drain current | I _{DR} | 50 | A |
| Channel dissipation | Pch Note 2 | 50 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Note: 1. PW \leq 10 μ s, duty cycle \leq 1%

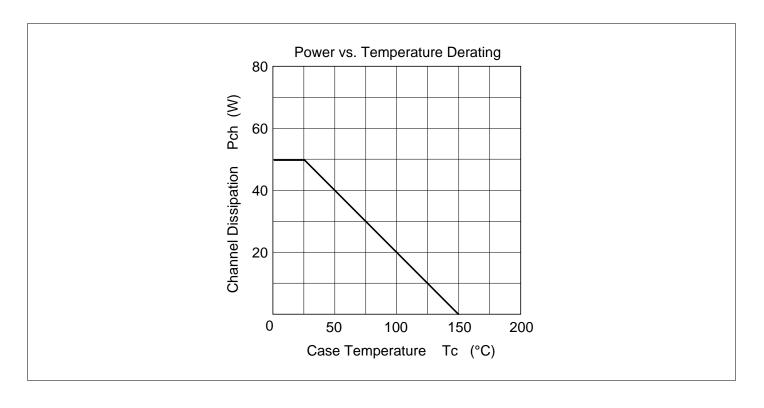
2. Value at Tc = 25°C

Electrical Characteristics $(Ta = 25^{\circ}C)$

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|--|---------------------|-----|-----|------|-----------|--|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 30 | _ | | V | $I_{D} = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | ±0.1 | μΑ | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$ |
| Zero gate voltege drain current | I _{DSS} | _ | _ | 10 | μΑ | $V_{DS} = 30 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | 1.0 | _ | 2.5 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note 1}}$ |
| Static drain to source on state | $R_{DS(on)}$ | _ | 7 | 10 | $m\Omega$ | $I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 1}}$ |
| resistance | | _ | 12 | 18 | $m\Omega$ | $I_{\rm D} = 25 \; {\rm A}, \; V_{\rm GS} = 4 \; {\rm V}^{\; {\rm Note} \; 1}$ |
| Forward transfer admittance | y _{fs} | TBD | TBD | _ | S | $I_{D} = 25 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 1}}$ |
| Input capacitance | Ciss | _ | TBD | _ | pF | V _{DS} = 10V |
| Output capacitance | Coss | _ | TBD | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | TBD | _ | pF | f = 1 MHz |
| Total gate charge | Qg | _ | TBD | _ | nc | V _{DD} = 10 V |
| Gate to source charge | Qgs | _ | TBD | _ | nc | $V_{GS} = 10 \text{ V}$ |
| Gate to drain charge | Qgd | | TBD | _ | nc | $I_{D} = 50 \text{ A}$ |
| Turn-on delay time | $t_{d(on)}$ | _ | TBD | | ns | $V_{GS} = 10 \text{ V}, I_{D} = 25 \text{ A}$ |
| Rise time | t _r | _ | TBD | _ | ns | $R_L = 0.4 \Omega$ |
| Turn-off delay time | t _{d(off)} | _ | TBD | _ | ns | _ |
| Fall time | t _f | _ | TBD | | ns | |
| Body-drain diode forward voltage | V_{DF} | _ | TBD | | V | $I_F = 50 \text{ A}, V_{GS} = 0$ |
| Body–drain diode reverse recovery time | t _{rr} | _ | TBD | _ | ns | $I_F = 50 \text{ A}, V_{GS} = 0$ diF/ dt = 50 A/ μ s |

Note: 1. Pulse test

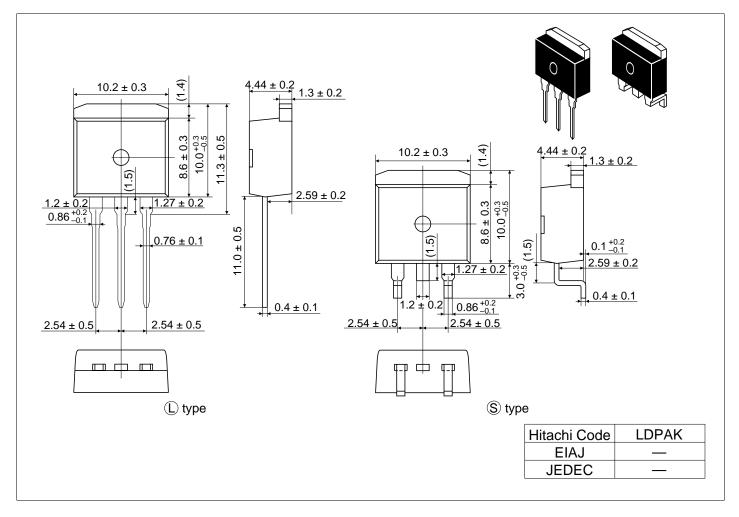
Main Characteristics



2SK3133(L),2SK3133(S)

Package Dimensions

Unit: mm



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Hitachi. Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park

Lower Cookham Road Maidenhead

Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd. Taipei Branch Office

3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong

Tel: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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